

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0740298450](#)
Status: **Active**
Overview: [vhdm](#)
Description: 2.00mm (.079") Pitch VHDM® Board-to-Board Backplane Receptacle Power Module, Vertical, 8-Row, 2 Circuits, Pin 2 Voided, Gold (Au) Selective 1.27µm (50µ")

Documents:

3D Model	Product Specification PS-74031-999 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)
Packaging Specification (PDF)	

Agency Certification

UL	E29179
----	--------

General

Product Family	Backplane Connectors
Series	74029
Application	Backplane
Application Tooling Documents	Tooling Manual
Comments	Backplane Receptacle Module, Power
Component Type	Power Receptacle
Overview	vhdm
Product Name	VHDM®
Style	N/A

Physical

Circuits (Loaded)	2
Circuits (maximum)	3
Circuits Detail	Pin 2 voided
Color - Resin	Black
Durability (mating cycles max)	200
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Number of Columns	N/A
Number of Pairs	Open Pin Field
Number of Rows	8
Orientation	Vertical
PC Tail Length (in)	0.110 In
PC Tail Length (mm)	2.80 mm
PCB Locator	No
PCB Retention	None
PCB Thickness Recommended (in)	0.070 In
PCB Thickness Recommended (mm)	1.80 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.157 In
Pitch - Term. Interface (mm)	4.00 mm
Plating min: Mating (µin)	50

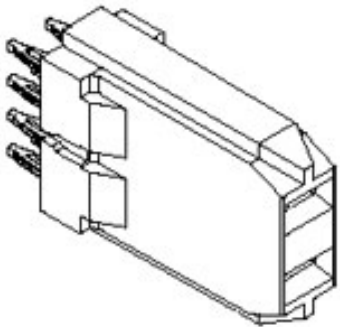


image - Reference only

Series

EU RoHS

RoHS Compliant by Exemption

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Halogen-Free

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[74029Series](#)

Mates With

[74026](#) VHDM® Board-to-Board Daughtercard Receptacle

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
VHDM® Backplane 6 and 8 Row Power Module Insertion Tool	0622020211

Plating min: Mating (μm)	1.25
Plating min: Termination (μin)	15
Plating min: Termination (μm)	0.375
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	10A
Data Rate	2.5 Gbps
Real Signals (per 25mm)	100
Shielded	No
Voltage - Maximum	250V

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-70873-0876
Product Specification	PS-74031-999
Sales Drawing	SD-74029-002, SD-74029-009

VHDM and Very High Density Metric are trademarks of Amphenol Corporation

This document was generated on 05/19/2010
PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

10

9

8

7

6

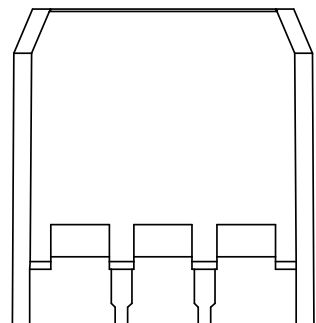
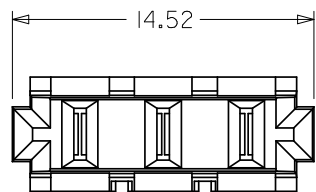
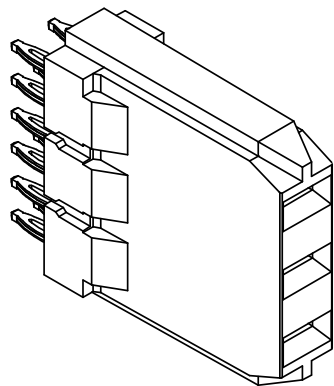
5

4

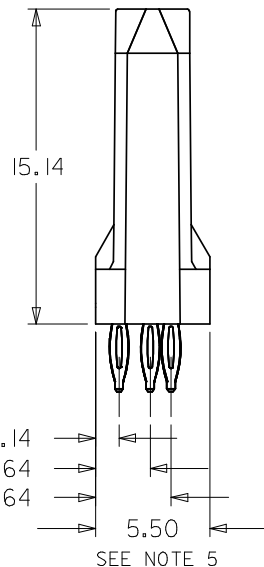
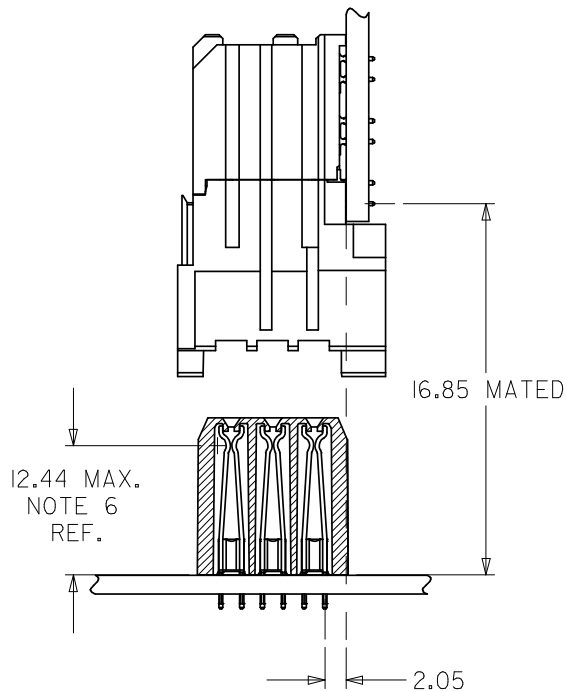
3

2

74029



(POSITION 1)
(POSITION 2)
(POSITION 3)
SEE NOTE 8 & CHART



NOTES:

1. MATERIALS:
HOUSING - LIQUID CRYSTAL POLYMER (LCP)
UL94 V-0 RATED, COLOR: BLACK
TERMINAL - COPPER ALLOY
2. FINISH: 30 MICROINCH MIN GOLD ON MATING SURFACE;
TIN/LEAD ON TAILS; NICKEL OVERALL.
3. FINISH: 50 MICROINCH MIN GOLD ON MATING SURFACE;
TIN/LEAD ON TAILS; NICKEL OVERALL.
4. THIS PART CONFORMS TO PRODUCT SPECIFICATION
PS-74031-999.
5. USE 6.00 mm NOMINAL FOR BACKPLANE LAYOUT.
6. DIMENSION MEASURED FROM BOTTOM OF HOUSING.
7. PACKED PER PK-70873-0876.
8. CONTACT NOT PRESENT AT POSITION ON
-84** ASSEMBLIES.

SIGNAL
ROW A

Y

REFERENCE
SIGNAL PATTERN

MIN. BOARD THICKNESS: 1.8 mm

Ø 0.725±0.075
PLATED THRU HOLE
Ø 1.20 PAD
Ø 0.838 DRILL

Ø 0.15 X Y

ASSEMBLY #	CONTACT PLATING	OPEN LOC.	# CONTACTS
74029-8000	SEE NOTE 2	N/A	3
74029-8050	SEE NOTE 3	N/A	
74029-8400	SEE NOTE 2	POS. 2	2
74029-8450	SEE NOTE 3	POS. 2	
74029-8401	SEE NOTE 2	POS. 1	
74029-8451	SEE NOTE 3	POS. 1	
74029-8403	SEE NOTE 2	POS. 3	
74029-8453	SEE NOTE 3	POS. 3	

REDRAWN
EC NO: UCP2008-1963
DRWN:JBINGHAM 2008/02/18
CHKD:JBINGHAM 2008/02/18
APPR:JLAURX 2008/02/18

QUALITY
SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES ±---	±---	±---
3 PLACES ±---	±---	±---
2 PLACES ±0.15	±---	±---
1 PLACE ±0.25	±---	±---

ANGULAR ±---°

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY

DRAWN BY	DATE
TELO	98/10/19
CHECKED BY	DATE
DBREARLEY	98/10/21
APPROVED BY	DATE
CBIXLER	98/10/22

MATERIAL NO.

SEE CHART

SIZE
BSCALE
NONE

TITLE

DESIGN UNITS
METRICTHIRD ANGLE
PROJECTION

VHDM POWER
8 ROW BACKPLANE
SALES ASSEMBLY

molex

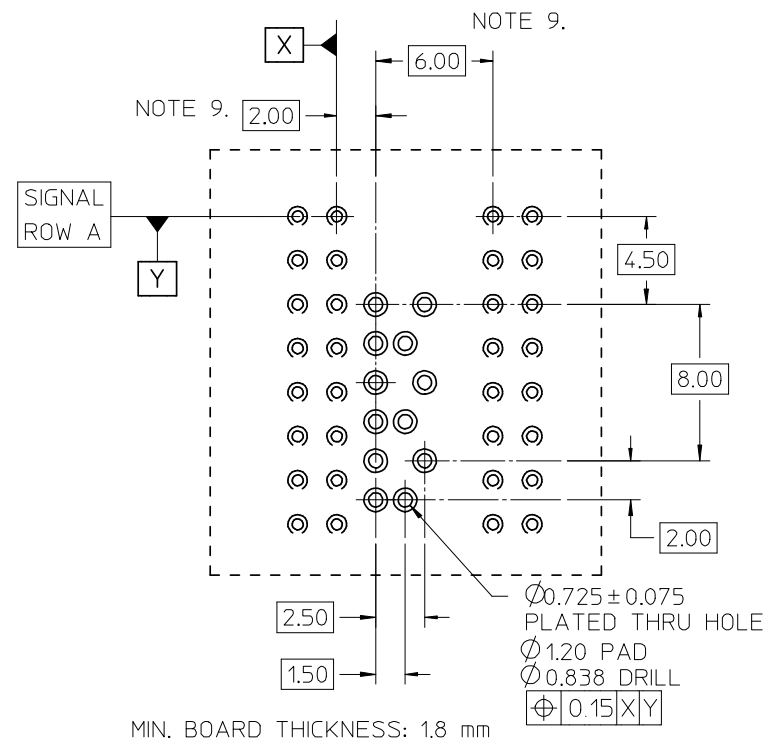
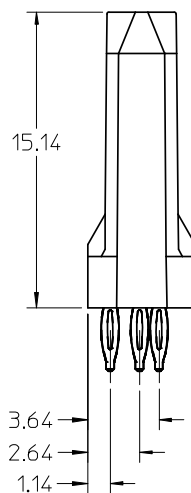
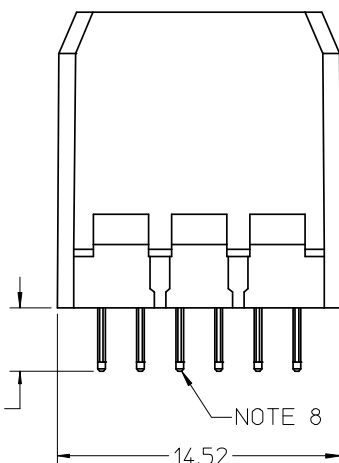
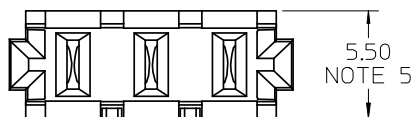
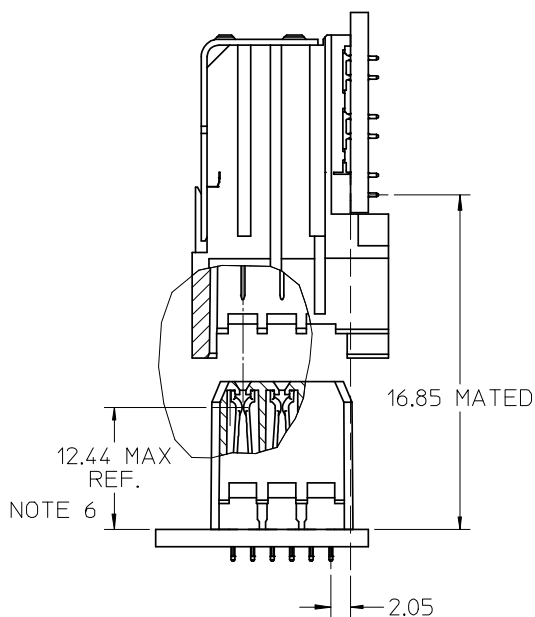
MOLEX INCORPORATED

DOCUMENT NO.

SD-74029-002

SHEET NO.

1 OF 1



- NOTES:
1. MATERIALS:
HOUSING - LIQUID CRYSTAL POLYMER (LCP)
UL94 V-0 RATED, COLOR: BLACK
TERMINAL - COPPER ALLOY
 2. FINISH: 30 microINCH MIN GOLD ON MATING SURFACE;
TIN/LEAD ON TAILS; NICKEL OVERALL.
 3. FINISH: 50 microINCH MIN GOLD ON MATING SURFACE;
TIN/LEAD ON TAILS; NICKEL OVERALL.
 4. THIS PART CONFORMS TO PRODUCT SPECIFICATION
PS-74031-999.
 5. USE 6.00 mm NOMINAL FOR BACKPLANE LAYOUT.
 6. DIMENSION MEASURED FROM BOTTOM OF HOUSING.
 7. PACKED PER PK-70873-0876.
 8. MIDDLE CONTACT NOT PRESENT ON -84** ASSEMBLIES.
 9. THIS DIMENSION TO BE MULTIPLE OF 2.00 mm AS REQUIRED.

ASSEMBLY #	CONTACT PLATING	# CONTACTS
74029-8000	SEE NOTE 2	3
74029-8050	SEE NOTE 3	3
74029-8400	SEE NOTE 2	2
74029-8450	SEE NOTE 3	2

REVISED (MINOR) EC NO: UCP2008-1963 DRWN: JINGHAM 2008/02/18 CHKD: 2008/02/18 APPR: JLAURX 2008/02/18 REV A1	QUALITY SYMBOLS ▽ = 0 ▽ = 0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)	mm		INCH		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	REVISE ON CAD ONLY	
				DIMENSION STYLE MM ONLY		TITLE HSD POWER 8 ROW BACKPLANE SALES ASSEMBLY						
				DRAWN BY ELO						DATE 2001/10/04		
				CHECKED BY GORSKI		DATE 2001/10/05		MOLEX MOLEX INCORPORATED				
				APPROVED BY BIXLER		DATE 2001/10/08						MATERIAL NO. SEE CHART
DRAFT WHERE APPLICABLE		MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								B

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9